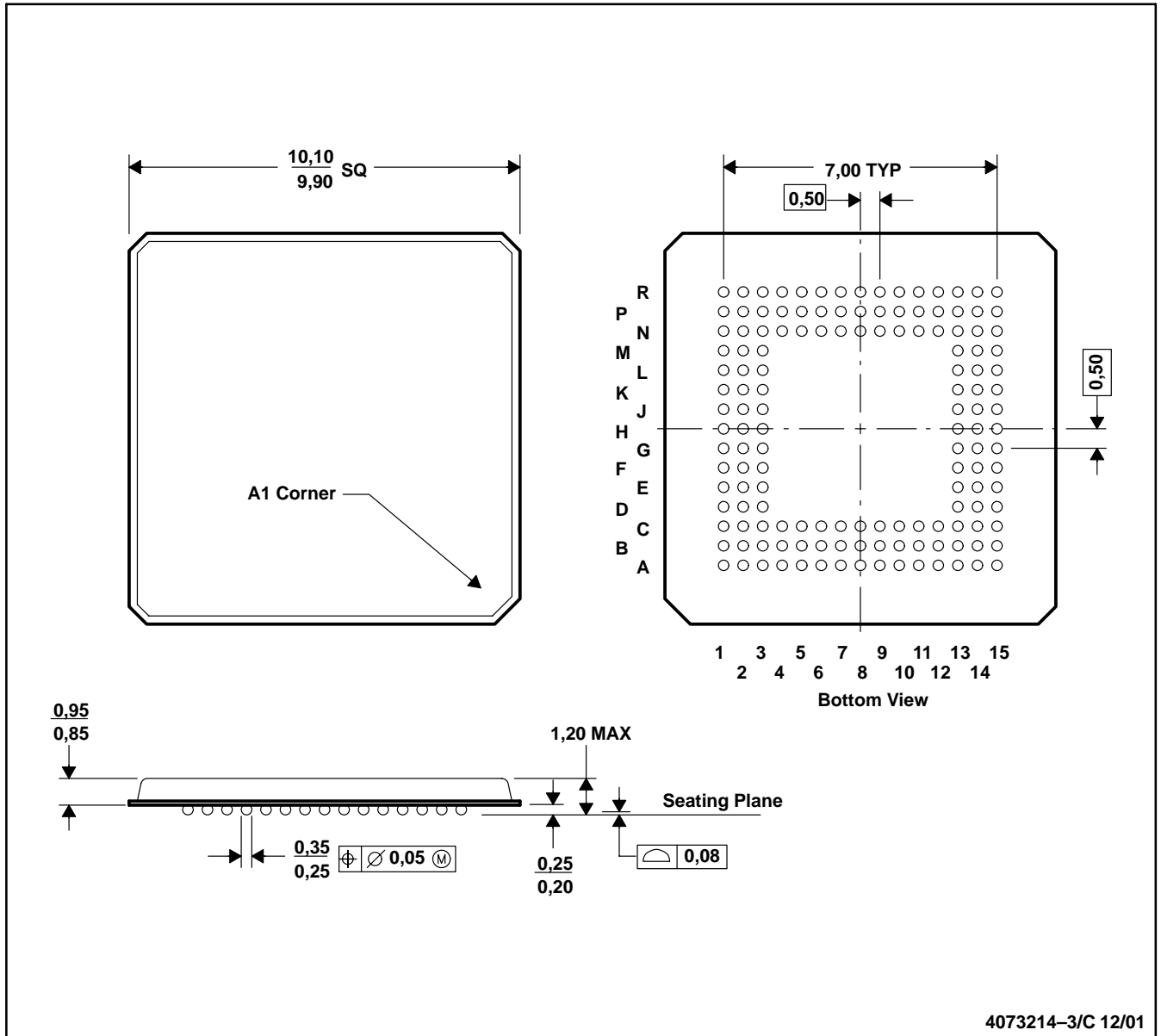


GGF (S-PBGA-N144)

PLASTIC BALL GRID ARRAY



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. MicroStar BGA configuration.

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### Mailing Address:

Texas Instruments  
Post Office Box 655303  
Dallas, Texas 75265